



CBR-SMD RF COG, Ceramic, 9.6 pF, +/-0.1 pF, 500 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0805



General Information	
Series	CBR-SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	12.03 mg
Notes	Solder Wave or Solder Reflow.
Shelf Life	78 Weeks
MSL	1

0805
2mm +/-0.2mm
1.25mm +/-0.2mm
0.85mm +/-0.1mm
0.5mm +/-0.2mm

В	0.5mm +/-0.2mm
Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

Specifications	
Capacitance	9.6 pF
Tolerance	+/-0.1 pF
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Dissipation Factor	0.169%
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms
Quality Factor	592

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